

## Single-Channel: 6N135M, 6N136M, HCPL4503M Dual-Channel: HCPL2530M, HCPL2531M (Preliminary) High Speed Transistor Optocouplers

### Features

- High speed –1 MBit/s
- Superior CMR – 10kV/μs
- Dual-Channel HCPL2530M, HCPL2531M (Preliminary)
- CTR guaranteed 0–70°C
- U.L. recognized (File # E90700, Vol. 2)
- VDE recognition (pending)
  - Ordering option 'V', e.g., 6N135VM
- 5,000Vrms (1 minute) isolation rating
- Superior CMR of 15,000V/μs min. (HCPL4503M)
- No base connection for improved noise immunity (HCPL4503M)

### Applications

- Line receivers
- Pulse transformer replacement
- Output interface to CMOS-LSTTL-TTL
- Wide bandwidth analog coupling

### Description

The HCPL4503M, 6N135M, 6N136M, HCPL2530M and HCPL2531M optocouplers consist of an AlGaAs LED optically coupled to a high speed photodetector transistor.

A separate connection for the bias of the photodiode improves the speed by several orders of magnitude over conventional phototransistor optocouplers by reducing the base-collector capacitance of the input transistor.

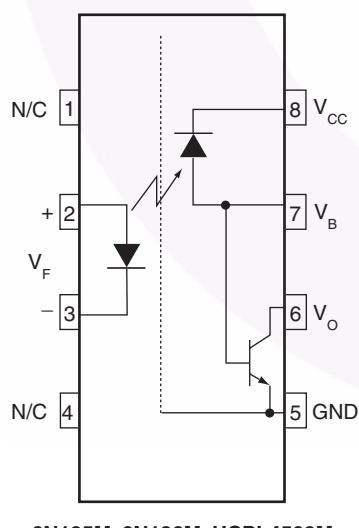
The HCPL4503M has no internal connection to the phototransistor base for improved noise immunity.

An internal noise shield provides superior common mode rejection of up to 50,000V/μs.

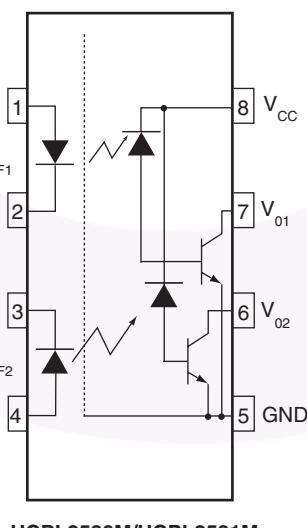
### Related Resources

- [www.fairchildsemi.com/products/opto/](http://www.fairchildsemi.com/products/opto/)
- [www.fairchildsemi.com/pf/HC/HCPL0500.html](http://www.fairchildsemi.com/pf/HC/HCPL0500.html)
- [www.fairchildsemi.com/pf/FO/FODM452.html](http://www.fairchildsemi.com/pf/FO/FODM452.html)
- [www.fairchildsemi.com/pf/FO/FOD050L.html](http://www.fairchildsemi.com/pf/FO/FOD050L.html)

### Schematics



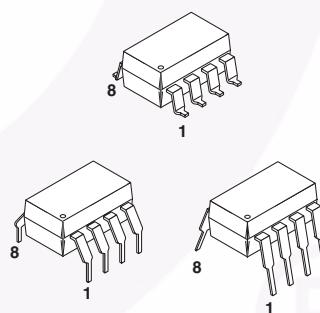
6N135M, 6N136M, HCPL4503M



HCPL2530M/HCPL2531M

Pin 7 is not connected in the  
HCPL4503M

### Package Outlines



**Absolute Maximum Ratings** ( $T_A = 25^\circ\text{C}$  unless otherwise specified)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

<b>Symbol</b>	<b>Parameter</b>	<b>Condition</b>	<b>Value</b>	<b>Units</b>
$T_{STG}$	Storage Temperature		-40 to +125	$^\circ\text{C}$
$T_{OPR}$	Operating Temperature		-40 to +100	$^\circ\text{C}$
$T_{SOL}$	Lead Solder Temperature (Wave)		260 for 10 sec	$^\circ\text{C}$
<b>EMITTER</b>				
$I_F$ (avg)	DC/Average Forward Input Current Each Channel <sup>(1)</sup>		25	mA
$I_F$ (pk)	Peak Forward Input Current Each Channel <sup>(2)</sup>	50% duty cycle, 1ms P.W.	50	mA
$I_F$ (trans)	Peak Transient Input Current Each Channel	$\leq 1\mu\text{s}$ P.W., 300pps	1.0	A
$V_R$	Reverse Input Voltage Each Channel		5	V
$P_D$	Input Power Dissipation Each Channel <sup>(3)</sup>	6N135M, 6N136M, HCPL4503M HCPL2530M, HCPL2531M	45	mW
<b>DETECTOR</b>				
$I_O$ (avg)	Average Output Current Each Channel		8	mA
$I_O$ (pk)	Peak Output Current Each Channel		16	mA
$V_{EBR}$	Emitter-Base Reverse Voltage	6N135M and 6N136M only	5	V
$V_{CC}$	Supply Voltage		-0.5 to 30	V
$V_O$	Output Voltage		-0.5 to 20	V
$I_B$	Base Current	6N135M and 6N136M only	5	mA
$P_D$	Output Power Dissipation Each Channel <sup>(4)</sup>	6N135M, 6N136M, HCPL4503M HCPL2530M, HCPL2531M	100 35	mW

**Notes:**

1. Derate linearly above  $70^\circ\text{C}$  free-air temperature at a rate of  $0.8\text{mA}/^\circ\text{C}$ .
2. Derate linearly above  $70^\circ\text{C}$  free-air temperature at a rate of  $1.6\text{mA}/^\circ\text{C}$ .
3. Derate linearly above  $70^\circ\text{C}$  free-air temperature at a rate of  $0.9\text{ mW}/^\circ\text{C}$ .
4. Derate linearly above  $70^\circ\text{C}$  free-air temperature at a rate of  $2.0\text{ mW}/^\circ\text{C}$ .

## Electrical Characteristics

( $T_A = 0$  to  $70^\circ\text{C}$  unless otherwise specified. Typical value is measured at  $T_A = 25^\circ\text{C}$  and  $V_{CC} = 5.0\text{V}$ .)

### Individual Component Characteristics

Symbol	Parameter	Test Conditions	Device	Min.	Typ.	Max.	Unit
<b>EMITTER</b>							
$V_F$	Input Forward Voltage	$I_F = 16\text{mA}, T_A = 25^\circ\text{C}$	All		1.45	1.7	V
		$I_F = 16\text{mA}$	All			1.8	
$B_{VR}$	Input Reverse Breakdown Voltage	$I_R = 10 \mu\text{A}$	All	5.0	21		V
$\Delta V_F/\Delta T_A$	Temperature Coefficient of Forward Voltage	$I_F = 16\text{mA}$	All		-1.7		$\text{mV}/^\circ\text{C}$
<b>DETECTOR</b>							
$I_{OH}$	Logic High Output Current	$I_F = 0\text{mA}, V_O = V_{CC} = 5.5\text{V}, T_A = 25^\circ\text{C}$	All		0.0007	0.5	$\mu\text{A}$
		$I_F = 0\text{mA}, V_O = V_{CC} = 15\text{V}, T_A = 25^\circ\text{C}$	6N135M 6N136M HCPL4503M		0.0019	1	
		$I_F = 0\text{mA}, V_O = V_{CC} = 15\text{V}$	All			50	
$I_{CCL}$	Logic Low Supply Current	$I_F = 16\text{mA}, V_O = \text{Open}, V_{CC} = 15\text{V}$	6N135M 6N136M HCPL4503M		163	200	$\mu\text{A}$
		$I_{F1} = I_{F2} = 16\text{mA}, V_O = \text{Open}, V_{CC} = 15\text{V}$	HCPL2530M HCPL2531M			400	
$I_{CCH}$	Logic High Supply Current	$I_F = 0\text{mA}, V_O = \text{Open}, V_{CC} = 15\text{V}, T_A = 25^\circ\text{C}$	6N135M 6N136M HCPL4503M		0.0002	1	$\mu\text{A}$
		$I_F = 0\text{mA}, V_O = \text{Open}, V_{CC} = 15\text{V}$	6N135M 6N136M HCPL4503M		0.0004	2	
		$I_F = 0\text{mA}, V_O = \text{Open}, V_{CC} = 15\text{V}$	HCPL2530M HCPL2531M			4	

### **Electrical Characteristics (Continued)**

( $T_A = 0$  to  $70^\circ\text{C}$  unless otherwise specified. Typical value is measured at  $T_A = 25^\circ\text{C}$  and  $V_{CC} = 5.0\text{V}$ .)

#### **Transfer Characteristics**

Symbol	Parameter	Test Conditions	Device	Min.	Typ.	Max.	Unit	
<b>COUPLED</b>								
CTR	Current Transfer Ratio <sup>(5)</sup>	$I_F = 16\text{mA}$ , $V_O = 0.4\text{ V}$ , $V_{CC} = 4.5\text{V}$ , $T_A = 25^\circ\text{C}$	6N135M	7	38	50	%	
			HCPL2530M					
			6N136M HCPL4503M	19	38	50	%	
			HCPL2531M					
		$I_F = 16\text{mA}$ , $V_{CC} = 4.5\text{V}$	$V_{OL} = 0.4\text{V}$	5			%	
			HCPL2530M					
			$V_{OL} = 0.4\text{V}$	15			%	
			HCPL2531M					
V <sub>OL</sub>	Logic LOW Output Voltage	$I_F = 16\text{mA}$ , $I_O = 1.1\text{mA}$ , $V_{CC} = 4.5\text{V}$ , $T_A = 25^\circ\text{C}$	6N135M		0.12	0.4	V	
			HCPL2530M			0.5		
		$I_F = 16\text{mA}$ , $I_O = 3\text{mA}$ , $V_{CC} = 4.5\text{V}$ , $T_A = 25^\circ\text{C}$	6N136M HCPL4503M		0.20	0.4		
			HCPL2531M			0.5		
		$I_F = 16\text{mA}$ , $I_O = 0.8\text{mA}$ , $V_{CC} = 4.5\text{V}$	6N135M		0.11	0.5		
			HCPL2530M					
		$I_F = 16\text{mA}$ , $I_O = 2.4\text{mA}$ , $V_{CC} = 4.5\text{V}$	HCPL4503M		0.18	0.5		
			HCPL2531M					

**Note:**

5. Current Transfer Ratio is defined as a ratio of output collector current,  $I_O$ , to the forward LED input current,  $I_F$ , times 100%.

## Electrical Characteristics (Continued)

( $T_A = 0$  to  $70^\circ\text{C}$  unless otherwise specified. Typical values are measured at  $T_A = 25^\circ\text{C}$  and  $V_{CC} = 5\text{V}$ .)

### Switching Characteristics ( $V_{CC} = 5\text{V}$ )

Symbol	Parameter	Test Conditions	Device	Min.	Typ.	Max.	Unit
$t_{PHL}$	Propagation Delay Time to Logic LOW	$T_A = 25^\circ\text{C}$ , $R_L = 4.1\text{k}\Omega$ , $I_F = 16\text{mA}^{(6)}$ (Fig. 7)	6N135M		0.23	1.5	$\mu\text{s}$
			HCPL2530M				
		$R_L = 1.9\text{k}\Omega$ , $I_F = 16\text{mA}$ , $T_A = 25^\circ\text{C}^{(7)}$ (Fig. 7)	6N136M HCPL4503M		0.25	0.8	$\mu\text{s}$
			HCPL2531M				
		$R_L = 4.1\text{k}\Omega$ , $I_F = 16\text{mA}^{(6)}$ (Fig. 7)	6N135M HCPL2530M			2.0	$\mu\text{s}$
$t_{PLH}$	Propagation Delay Time to Logic HIGH	$R_L = 1.9\text{k}\Omega$ , $I_F = 16\text{mA}^{(7)}$ (Fig. 7) $T_A = 25^\circ\text{C}$	6N136M HCPL4503M HCPL2531M			1.0	$\mu\text{s}$
		$T_A = 25^\circ\text{C}$ , ( $R_L = 4.1\text{k}\Omega$ , $I_F = 16\text{mA}^{(6)}$ (Fig. 7))	6N135M		0.45	1.5	$\mu\text{s}$
			HCPL2530M				
		$R_L = 4.1\text{k}\Omega$ , $I_F = 16\text{mA}^{(6)}$ (Fig. 7)	6N136M HCPL4503M		0.26	0.8	$\mu\text{s}$
			HCPL2531M				
$ CM_H $	Common Mode Transient Immunity at Logic High	$I_F = 0\text{mA}$ , $V_{CM} = 10\text{V}_{P-P}$ , $R_L = 4.1\text{k}\Omega$ , $T_A = 25^\circ\text{C}^{(8)}$ (Fig. 8)	6N135M HCPL2530M		10,000		$\text{V}/\mu\text{s}$
		$I_F = 0\text{mA}$ , $V_{CM} = 10\text{V}_{P-P}$ , $R_L = 1.9\text{k}\Omega$ , $T_A = 25^\circ\text{C}^{(8)}$ (Fig. 8)	6N136M HCPL2531M		10,000		$\text{V}/\mu\text{s}$
		$I_F = 0\text{mA}$ , $V_{CM} = 1,500\text{V}_{P-P}$ , $R_L = 1.9\text{k}\Omega$ , $T_A = 25^\circ\text{C}^{(8)}$ (Fig. 8)	HCPL4503M	15,000	50,000		
$ CM_L $	Common Mode Transient Immunity at Logic Low	$I_F = 16\text{mA}$ , $V_{CM} = 10\text{V}_{P-P}$ , $R_L = 4.1\text{k}\Omega$ , $T_A = 25^\circ\text{C}^{(8)}$ (Fig. 8)	6N135M HCPL2530M		10,000		$\text{V}/\mu\text{s}$
		$I_F = 16\text{mA}$ , $V_{CM} = 10\text{V}_{P-P}$ , $R_L = 1.9\text{k}\Omega^{(8)}$ (Fig. 8)	6N136M HCPL2531M		10,000		$\text{V}/\mu\text{s}$
		$I_F = 0\text{mA}$ , $V_{CM} = 1,500\text{V}_{P-P}$ , $R_L = 1.9\text{k}\Omega$ , $T_A = 25^\circ\text{C}^{(8)}$ (Fig. 8)	HCPL4503M	15,000	50,000		

#### Notes:

- The  $4.1\text{k}\Omega$  load represents 1 LSTTL unit load of  $0.36\text{mA}$  and  $6.1\text{k}\Omega$  pull-up resistor.
- The  $1.9\text{k}\Omega$  load represents 1 TTL unit load of  $1.6\text{mA}$  and  $5.6\text{k}\Omega$  pull-up resistor.
- Common mode transient immunity in logic high level is the maximum tolerable (positive)  $dV_{cm}/dt$  on the leading edge of the common mode pulse signal  $V_{CM}$ , to assure that the output will remain in a logic high state (i.e.,  $V_O > 2.0\text{V}$ ). Common mode transient immunity in logic low level is the maximum tolerable (negative)  $dV_{cm}/dt$  on the trailing edge of the common mode pulse signal,  $V_{CM}$ , to assure that the output will remain in a logic low state (i.e.,  $V_O < 0.8\text{V}$ ).

## **Electrical Characteristics (Continued)**

( $T_A = 0$  to  $70^\circ\text{C}$  unless otherwise specified. Typical values are measured at  $T_A = 25^\circ\text{C}$  and  $V_{CC} = 5\text{V}$ .)

### **Isolation Characteristics ( $T_A = 0$ to $70^\circ\text{C}$ Unless otherwise specified)**

<b>Symbol</b>	<b>Characteristics</b>	<b>Test Conditions</b>	<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>	<b>Unit</b>
$V_{ISO}$	Withstand Insulation Test Voltage	$RH \leq 50\%$ , $T_A = 25^\circ\text{C}$ , $I_{I-O} \leq 10\mu\text{A}$ , $t = 1$ min., $f = 50\text{Hz}$ <sup>(9)(11)</sup>	5,000			$\text{V}_{\text{RMS}}$
$R_{I-O}$	Resistance (Input to Output)	$V_{I-O} = 500\text{VDC}$ <sup>(9)</sup>		$10^{11}$		$\Omega$
$C_{I-O}$	Capacitance (Input to Output)	$f = 1\text{MHz}$ , $V_{I-O} = 0\text{V}$ <sup>(9)</sup>		1		$\text{pF}$
$I_{I-I}$	Input-Input Insulation Leakage Current	$RH \leq 45\%$ , $V_{I-I} = 500\text{VDC}$ <sup>(10)</sup> $t = 5$ s, (HCPL2530M/2531M only)				$\mu\text{A}$
$R_{I-I}$	Input-Input Resistance	$V_{I-I} = 500\text{ VDC}$ <sup>(10)</sup> (HCPL2530M/2531M only)				$\Omega$
$C_{I-I}$	Input-Input Capacitance	$f = 1\text{MHz}$ <sup>(10)</sup> (HCPL2530M/2531M only)				$\text{pF}$

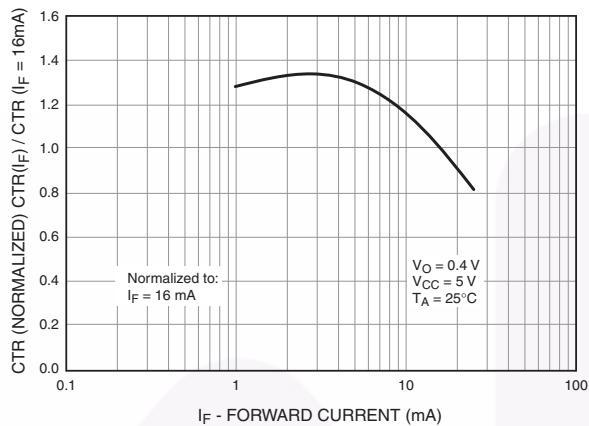
#### **Notes:**

9. Device is considered a two terminal device: Pins 1, 2, 3 and 4 are shorted together and Pins 5, 6, 7 and 8 are shorted together.
10. Measured between pins 1 and 2 shorted together, and pins 3 and 4 shorted together.
11. 5,000Vrms for 1 minute duration is equivalent to 6,000Vrms for 1 second duration.

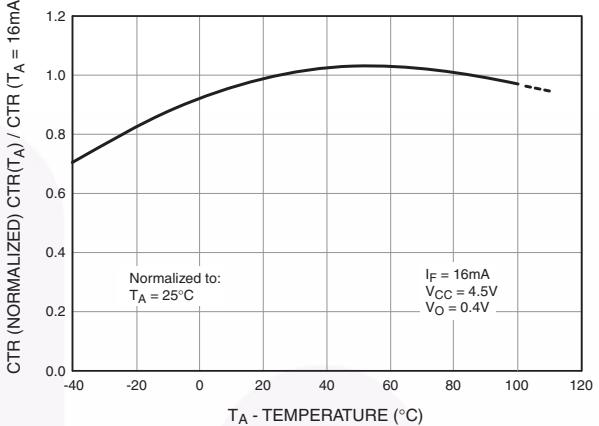
**Single-Channel: 6N135M, 6N136M, HCPL4503M  
Dual-Channel: HCPL2530M, HCPL2531M — High Speed Transistor Optocouplers**

## Typical Performance Curves

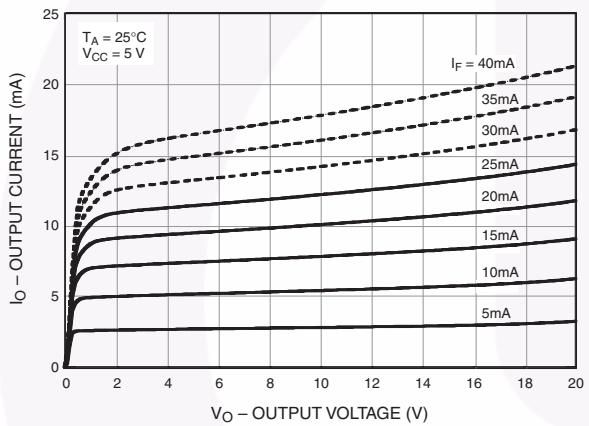
**Fig. 1 Normalized CTR vs. Forward Current**



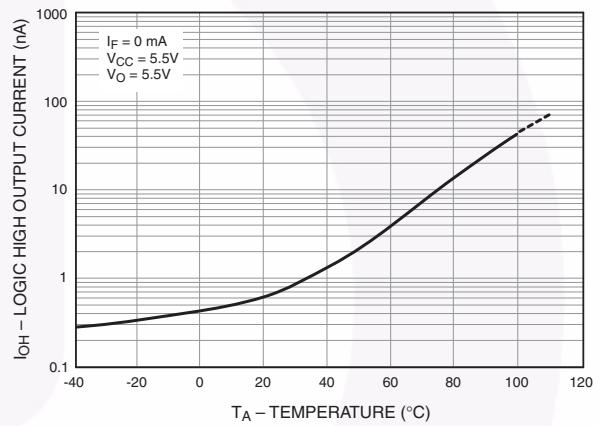
**Fig. 2 Normalized CTR vs. Temperature**



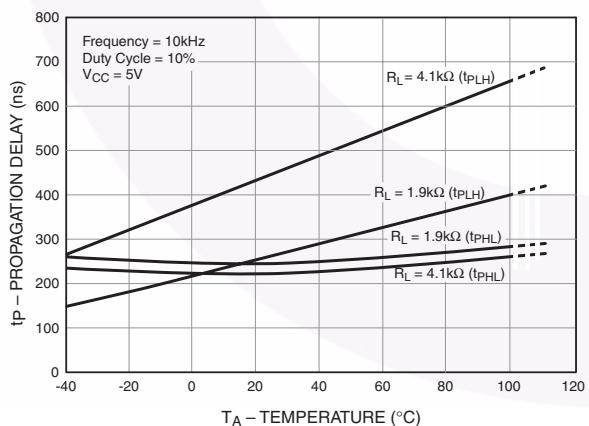
**Fig. 3 Output Current vs. Output Voltage**



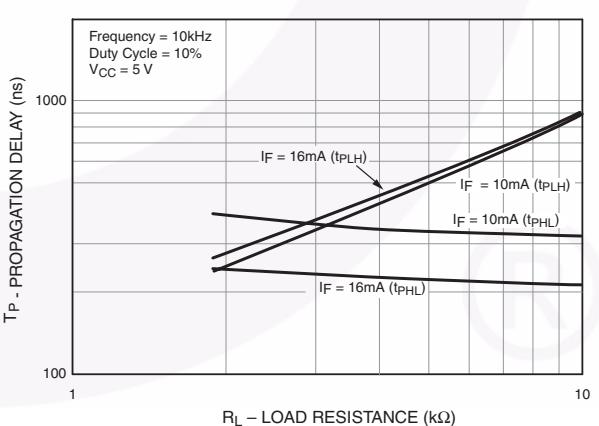
**Fig. 4 Logic High Output Current vs. Temperature**



**Fig. 5 Propagation Delay vs. Temperature**

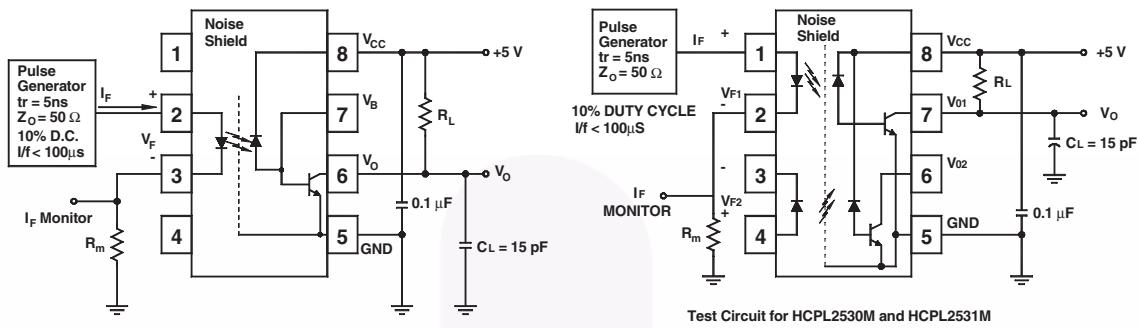


**Fig. 6 Propagation Delay vs. Load Resistance**



**Single-Channel: 6N135M, 6N136M, HCPL4503M  
Dual-Channel: HCPL2530M, HCPL2531M — High Speed Transistor Optocouplers**

## Test Circuits



Test Circuit for 6N135M, 6N136M, and HCPL4503M

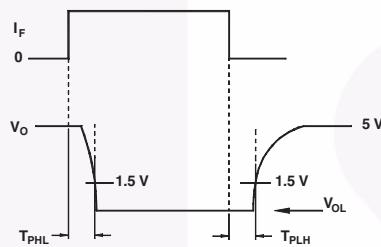
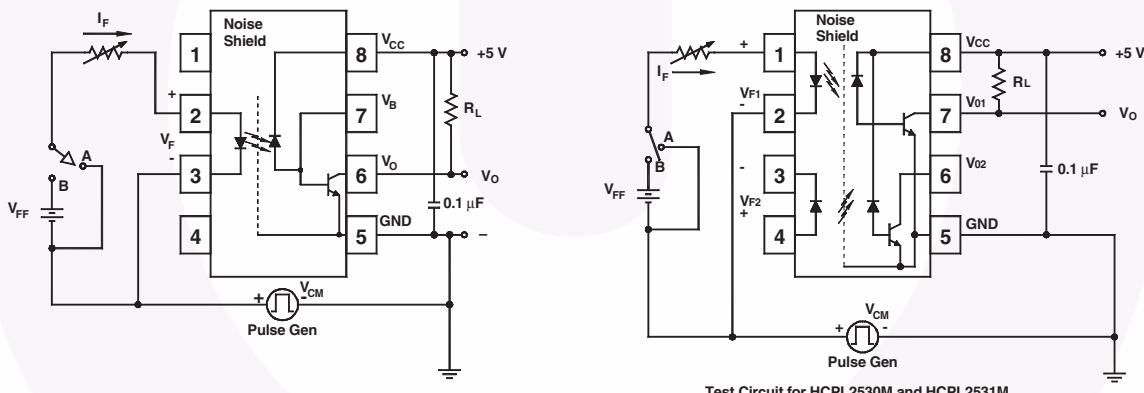


Fig. 7 Switching Time Test Circuit



Test Circuit for 6N135M, 6N136M, and HCPL4503M

Test Circuit for HCPL2530M and HCPL2531M

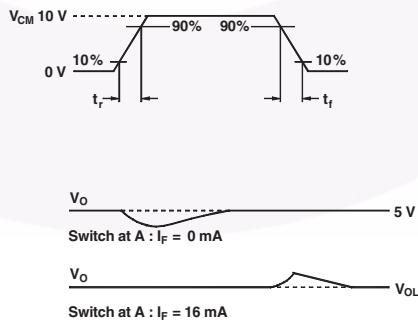
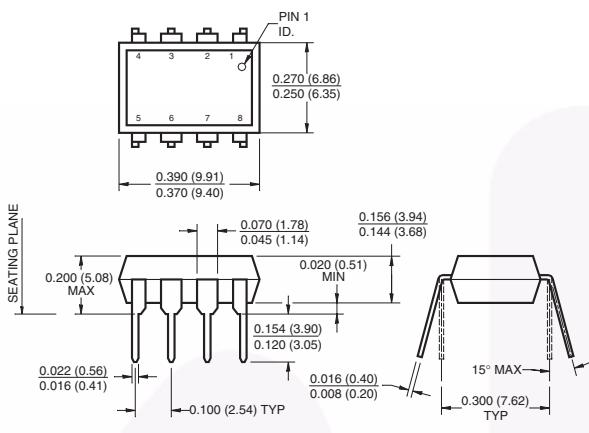


Fig. 8 Common Mode Immunity Test Circuit

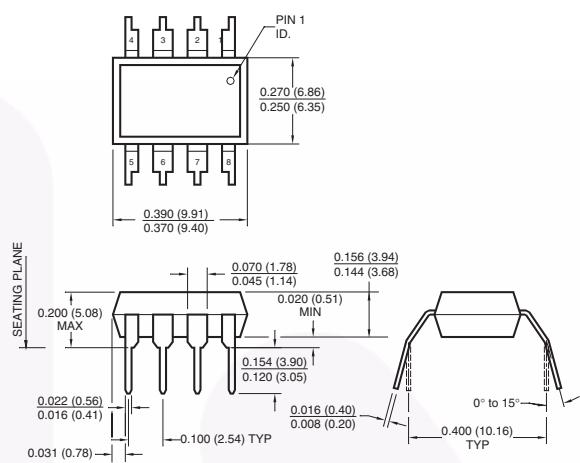
**Single-Channel: 6N135M, 6N136M, HCPL4503M  
Dual-Channel: HCPL2530M, HCPL2531M — High Speed Transistor Optocouplers**

## Package Dimensions

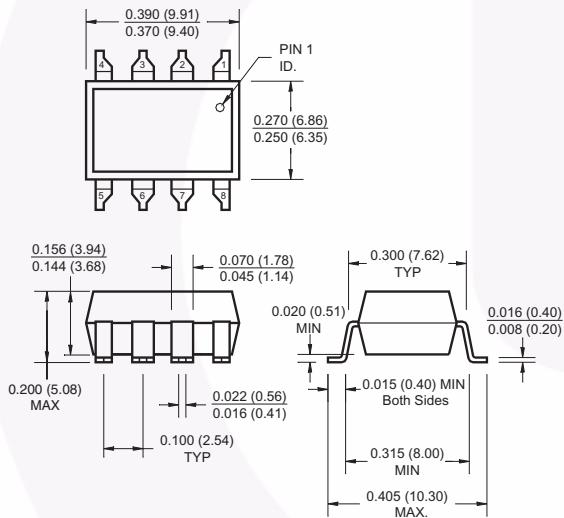
### Through Hole



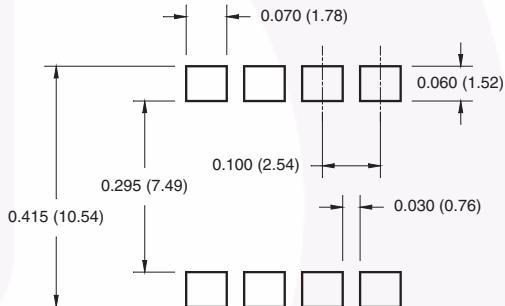
### 0.4" Lead Spacing (Option T)



### Surface Mount – 0.3" Lead Spacing (Option S)



### 8-Pin Surface Mount DIP – Land Pattern (Option S)



#### Note:

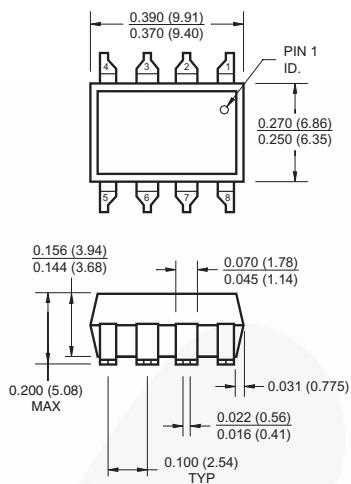
All dimensions are in inches (millimeters)

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

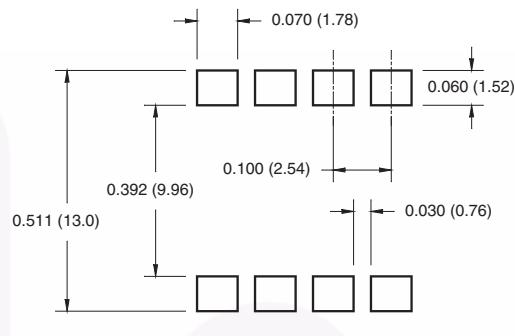
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<http://www.fairchildsemi.com/packaging/>

## Package Dimensions (Continued)

### Surface Mount – 0.4" Lead Spacing (Option TS) (Pending)



### 8-Pin Surface Mount DIP – Land Pattern (Option TS)



**Note:**

All dimensions are in inches (millimeters)

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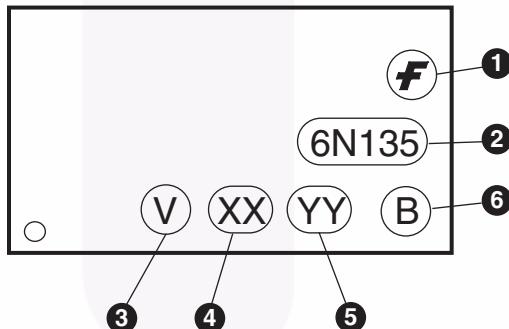
Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

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## Ordering Information

Option	Example Part Number	Description
No option	6N135M	Standard through hole lead form (50 units per tube)
S	6N135SM	Surface mount lead bend
SD	6N135SDM	Surface mount; tape and reel
V	6N135VM	IEC60747-5-2 (approval pending)
TSV	6N135TSVM	IEC60747-5-2 (approval pending); surface mount
TSDV	6N135TSDVM	IEC60747-5-2 (approval pending); surface mount; tape and reel
TV	6N135TVM	IEC60747-5-2 (approval pending); 0.4" lead spacing
SV	6N135SVM	IEC60747-5-2 (approval pending); surface mount
SDV	6N135SDVM	IEC60747-5-2 (approval pending); surface mount; tape and reel

## Marking Information



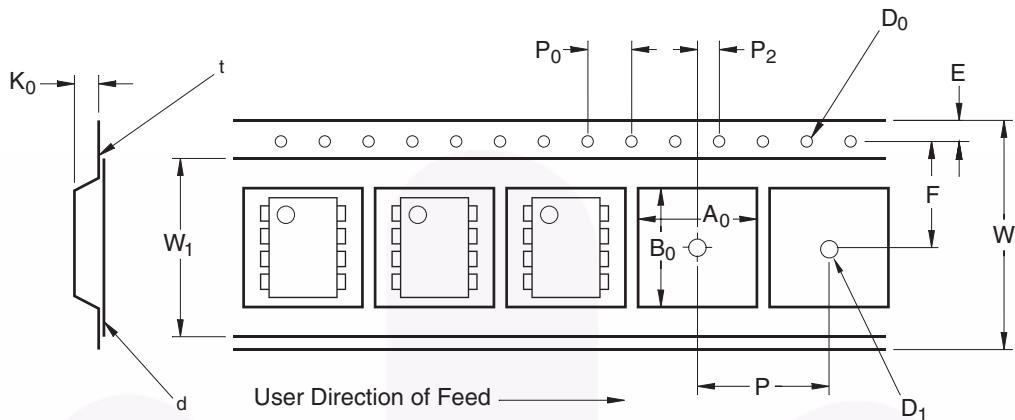
### Definitions

1	Fairchild logo
2 <sup>(1)</sup>	Device number
3	IEC60747-5-2 mark (Note: Only appears on parts ordered with this option – See order entry table)
4	Two digit year code, e.g., '08'
5	Two digit work week ranging from '01' to '53'
6	Assembly package code

### Note:

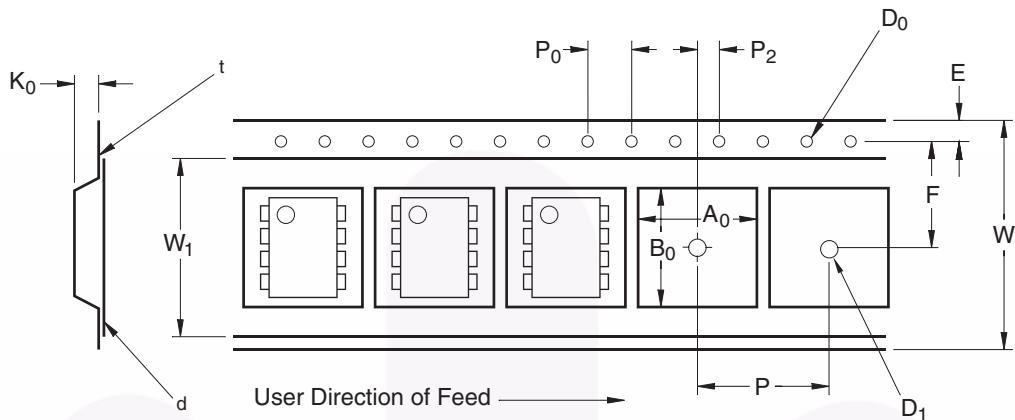
- 'HCPL' devices are marked with only the numeric characters (for example, HCPL4503M is marked as '4503').
- The 'M' suffix is an ordering identifier only. It is used to indicate the white package version. The 'M' does not appear in the top mark.

## Carrier Tape Specifications (Option SD)



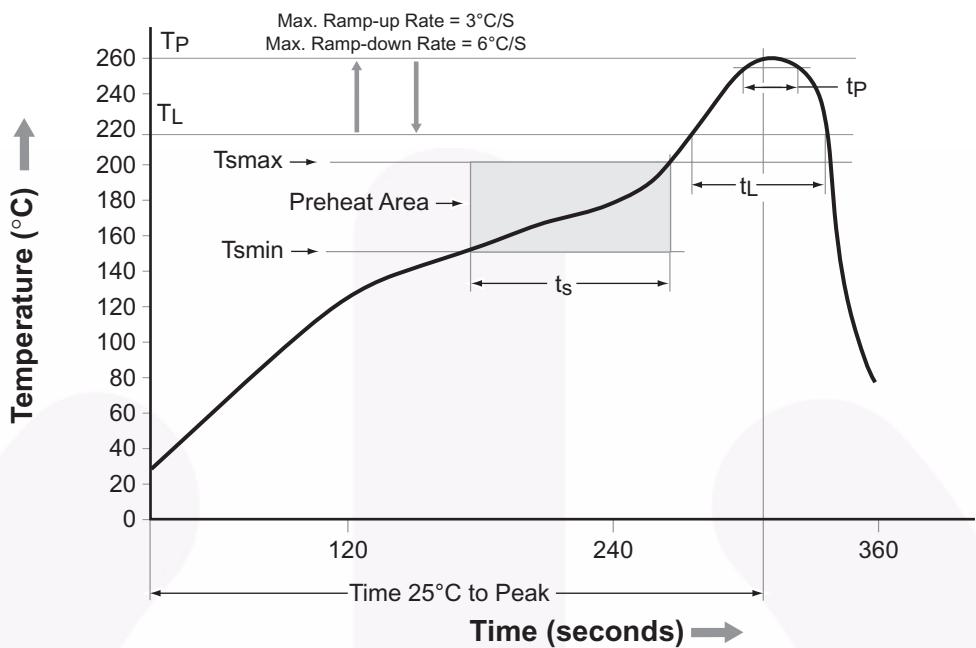
Symbol	Description	Dimension in mm
$W$	Tape Width	$16.0 \pm 0.3$
$t$	Tape Thickness	$0.30 \pm 0.05$
$P_0$	Sprocket Hole Pitch	$4.0 \pm 0.1$
$D_0$	Sprocket Hole Diameter	$1.55 \pm 0.05$
$E$	Sprocket Hole Location	$1.75 \pm 0.10$
$F$	Pocket Location	$7.5 \pm 0.1$
$P_2$		$2.0 \pm 0.1$
$P$	Pocket Pitch	$12.0 \pm 0.1$
$A_0$	Pocket Dimensions	$10.30 \pm 0.20$
$B_0$		$10.30 \pm 0.20$
$K_0$		$4.90 \pm 0.20$
$W_1$	Cover Tape Width	$13.2 \pm 0.2$
$d$	Cover Tape Thickness	0.1 max
	Max. Component Rotation or Tilt	$10^\circ$
$R$	Min. Bending Radius	30

## Carrier Tape Specifications (Option TSR2) (Pending)



Symbol	Description	Dimension in mm
$W$	Tape Width	$24.0 \pm 0.3$
$t$	Tape Thickness	$0.40 \pm 0.1$
$P_0$	Sprocket Hole Pitch	$4.0 \pm 0.1$
$D_0$	Sprocket Hole Diameter	$1.55 \pm 0.05$
$E$	Sprocket Hole Location	$1.75 \pm 0.10$
$F$	Pocket Location	$11.5 \pm 0.1$
$P_2$		$2.0 \pm 0.1$
$P$	Pocket Pitch	$16.0 \pm 0.1$
$A_0$	Pocket Dimensions	$12.80 \pm 0.1$
$B_0$		$10.35 \pm 0.1$
$K_0$		$5.7 \pm 0.1$
$W_1$	Cover Tape Width	$21.0 \pm 0.1$
$d$	Cover Tape Thickness	0.1 max
	Max. Component Rotation or Tilt	$10^\circ$
$R$	Min. Bending Radius	30

## Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (T <sub>smin</sub> )	150°C
Temperature Max. (T <sub>smax</sub> )	200°C
Time (t <sub>s</sub> ) from (T <sub>smin</sub> to T <sub>smax</sub> )	60–120 seconds
Ramp-up Rate (t <sub>L</sub> to t <sub>P</sub> )	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60–150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

# Single-Channel: 6N135M, 6N136M, HCPL4503M Dual-Channel: HCPL2530M, HCPL2531M — High Speed Transistor Optocouplers



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